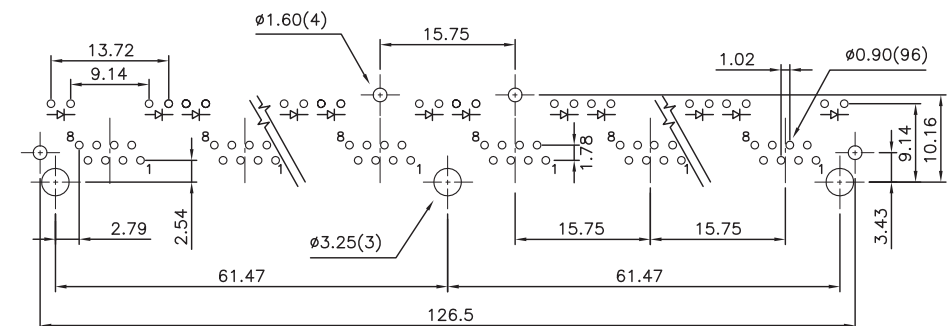
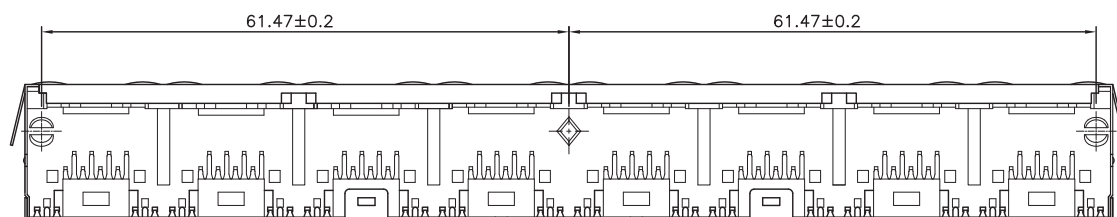
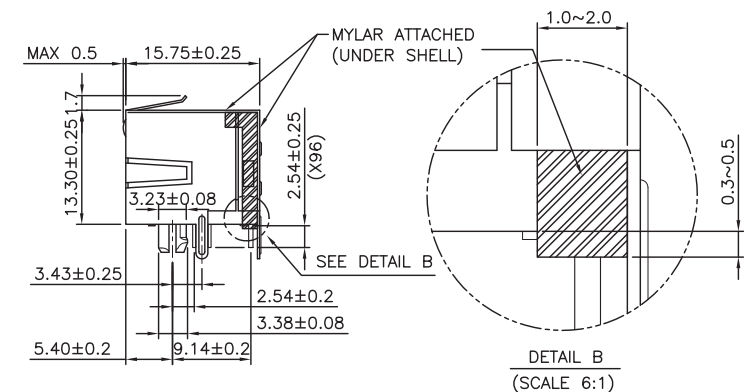
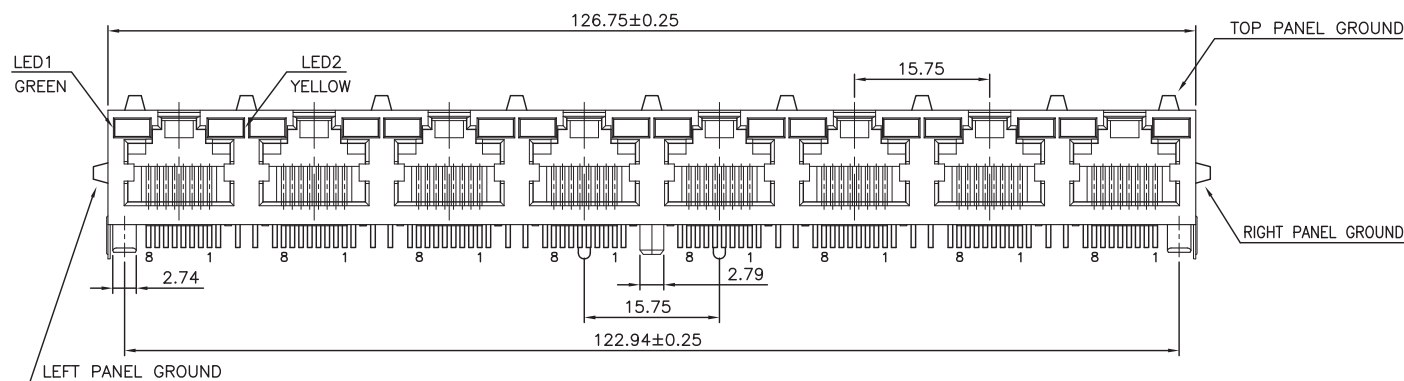


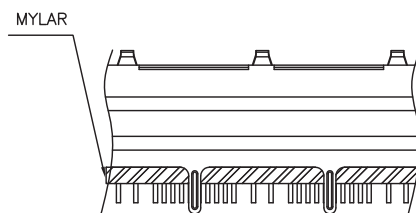
MATERIAL:

- HOUSING—DSM STANYL TE250F6 (NYLON—46)
HEAT DEFLECTION TEMP.290°
BLACK COLOR, UL94V-0
- CONTACTS—0.35mm THICK PHOS—BRONZE PLATED
WITH 6u" HARD GOLD AND GOLD FLASH ON
SOLDER AREA.
- SHIELD—0.25mm THICK COPPER ALLOY,
PLATED WITH NICKEL.

CAVITY CONFIRMS TO FCC RULES AND REGULATIONS
PART 68,SUBPART F.



PCB Layout (Ref.)



BLACK VIEW

DO NOT SCALE DRAWING	TOLERANCES UNLESS OTHERWISE NOTED	INCH	MM	DR. <i>M.L.HUANG</i>	DATE JUL-30 '13	 Mega-Chip Electronics Pte Ltd				
 THIRD ANGLE PROJECTION	LINEAR $\frac{\text{MM}}{\text{INCH}}$ 00 ± .01 000 ± .005 0000 ± .002	00 ± .01 000 ± .005 0000 ± .002	0.0±0.25 0.00±0.13 0.000±0.05	CK'D <i>M.CHANG</i>	JUL-30 '13	TITLE 8PORTS, RJ45, WITH LED'S SHIELDED, SIDE ENTRY PCB GANGED JACK				
MM INCH	ANGLE ± 0° 30'	RADII	$\pm \frac{0.40}{0.15}$	APP'D <i>W.J.YANG</i>	JUL-31 '13	SCALE	SIZE	DWG.NO. 971427	REV. 6	SHEET 1